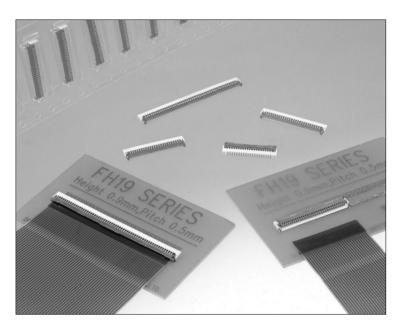
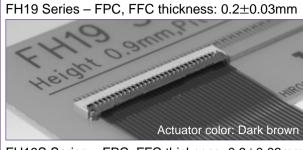
# World's smallest & lightest

# 0.5mm pitch, 0.9mm above the board, Flexible Printed Circuit & Flexible Flat Cable Connectors

### FH19 & FH19S Series





FH19S Series - FPC, FFC thickness: 0.3±0.03mm



#### Features

## World's smallest & lightest

### 1. Low-profile 0.5mm pitch FPC, FFC Connectors

Miniaturization of portable equipment and personal mobile devices has created increased demand for a low profile, high density, and high reliability connectors.

\*The design of this connector has been made thinner and smaller, with a height of 0.9mm and width of 3mm.

[As of August 2002, this is the smallest connector of this type available on the market !]

\*PCB footprint: Reduced approximately 48% (as compared with Hirose Electric's 0.5mm pitch FH12 Series connectors)

\*Connector weight: Reduced approximately 78% (as compared with Hirose Electric's 0.5mm pitch FH12 Series connectors)

#### 2. Conductive traces on the PCB can be designed to run under the connector

All bottom surface of the connector is solid, without any exposure of the contact.

#### 3. Proven Flip-Lock Actuator System assures easy and reliable operation

Rotating actuator permits easy insertion and reliable connection with the FPC & FFC.

Tactile sensation confirms complete mechanical locking of the actuator and the electrical connection.

### 4. Accepts 0.2mm & 0.3mm thick FPC, FFC

Accepts 0.2mm & 0.3mm thick FPC, FFC, easy inserted in the connector.

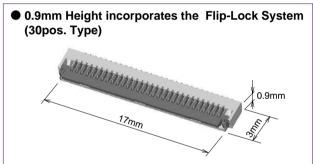
The connector will also terminate successfully with 0.2mm thick Flat Flexible Cable (FFC).

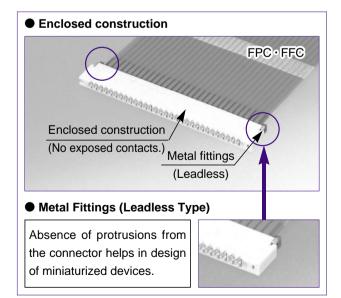
#### 5. Designed for placement with automatic equipment Packaged in embossed tape, on reel.

One reel contains 5,000 pieces.

#### 6. Environmental considerations

The center cores of the embossed tape reels are made of paper, unlike typical cores made of styrofoam.





#### Applications

Notebook PC's, PDA's, digital cameras and other compact devices requiring interconnections of the main circuit board with the LCD, plasma display (PDP), HDD or other devices.

**■**Product Specifications

Rating	Current rating 0.5 A DC	Operating temperature range -55℃ to +80℃ (Note 1)	Storage temperature range -10°C to +50°C (Note 2)
	Voltage rating 50 V AC	Operating humidity range	Storage humidity range
		Relative humidity 90% max. (No condensation)	Relative humidity 90% max.

Recommended	FH19 Series	Thickness: = $0.2 \pm 0.03$ mm Tin-lead plating (Note 3)
FPC, FFC	FH19S Series	Thickness: = $0.3 \pm 0.03$ mm Tin-lead plating (Note 3)

Item	Specification	Conditions
1. Insulation resistance	500 M ohms min.	100 V DC
2. Withstanding voltage	No flashover or insulation breakdown	150 V AC/1 minute
3. Contact resistance	100 m ohms max. <b>≯</b> Including FPC/FFC conductor resistance	1 mA
4. Durability (insertion/ withdrawal)	Contact resistance: 100 m ohms max. No damage, cracks, or parts dislocation.	20 cycles
5. Vibration	No electrical discontinuity of 1 μs or more. Contact resistance: 100 m ohms max. No damage, cracks, or parts dislocation.	Frequency: 10 to 55 Hz, single amplitude of 0.75mm, 2 hours in each of the 3 directions
6. Shock	No electrical discontinuity of 1 $\mu$ s. min. Contact resistance: 100 m ohms max. No damage, cracks, or parts dislocation.	Acceleration of 981 m/s², 6 ms duration, sine half-wave waveform, 3 cycles in each of the 3 axis.
7. Humidity (Steady state)	Contact resistance: 100 m ohms max. Insulation resistance: 100 M ohms min. No damage, cracks, or parts dislocation.	96 hours at temperature of 40℃ and humidity of 90 to 95%
8. Temperature cycle	Contact resistance: 100 m ohms max. Insulation resistance: 100 M ohms min. No damage, cracks, or parts dislocation.	Temperature: $-40^{\circ}C \rightarrow +15^{\circ}C$ to $+35^{\circ}C \rightarrow +85^{\circ}C \rightarrow +15^{\circ}C$ to $+35^{\circ}C$ Time: $30 \rightarrow 2$ to $3 \rightarrow 30 \rightarrow 2$ to $3(Minutes)$ 5 cycles
9. Resistance to soldering heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 350°C±5°C for 5 seconds

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers non- conducting condition of installed connectors in storage, shipment or during transportation.

Note 3: When FPC is gold plated, the connector contacts should be also gold plated: Select the (05) specification.

### **■**Materials

Part	Material	Finish	Remarks
	LCP	Color: Beige	
Insulator	PPS	Color: Dark brown (FH19 Series) Color: Black (FH19S Series)	UL94V-0
Contacts	Phosphor bronze	Tin-lead plating (Note 3)	
Metal fittings	Phosphor bronze	Pure tin reflow plating	

# **■**Ordering information

1 Series name :	FH19	4 Contact pitch : 0.5mm
② Blank : S :	FPC,FFC thickness : 0.2mm FPC,FFC thickness : 0.3mm	Terminal type     SH: SMT horizontal mounting type
3 No. of contacts :	4 to 50	(05): Gold plating (51): Tin-lead plating

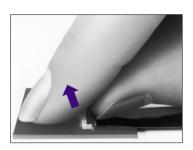
# **◆** Connector Operating Instructions, Precautions and Recommendations

# 1. FPC/FFC Termination procedure. Connector installed on the board.

Operation

- 1) Lift up the actuator. Use thumb or index finger.
- 1) Do not apply excessive force or use any type of tool to operate the actuator.

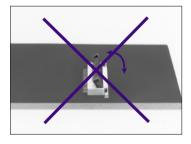
**Precautions** 







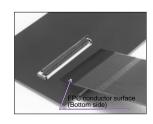
- 2) Rotate down the actuator until firmly closed. It is critical that the inserted FPC/FFC is not moved and remains fully inserted. Should the FPC/FFC be moved, open the actuator and repeat the process, starting with Step 1 above.
- 2) The connector will assure reliable performance when the actuator is open to 130° maximum (see fig.1) Do not exceed this angle, as this may cause permanent damage to the connector.



- 2. FPC/FFC Removal
- 1) Lift up the actuator.
- 2) Carefully remove the FPC/FFC.



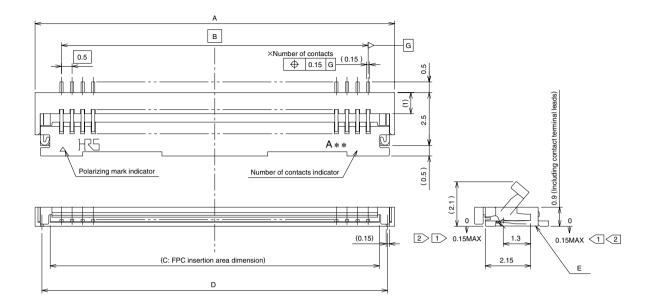
3) Assure that the FPC/FFC is fully inserted parallel to mounting surface, with the exposed conductive traces facing down.





### **■**Connector Dimension

[FH19 Series]



Notes  $\boxed{1}$  The coplanarity of each terminal lead and metal fitting is within 0.1

 $|2\rangle$  The contact terminal lead position indicates the dimension from the E surface, the bottom surface of the insulator body.

3 The connector is supplied in embossed tape packaging. For details see the Packaging Specifications.

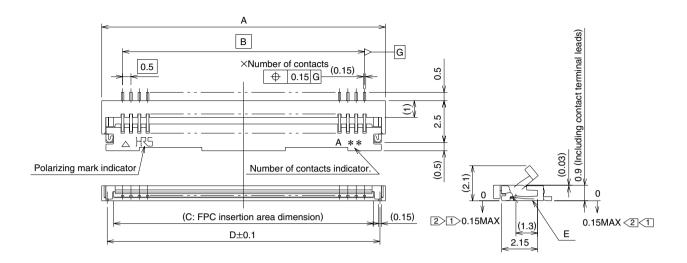
4 Any discoloration of the plastic compound will NOT AFFECT form, fit or function of the connector.

Unit: mm

Part Number	CL No.	Number of Contacts	Α	В	С	D
FH19-4S-0.5SH(51)	586-1009-8-51	4	4.0	1.5	2.57	3.35
FH19-6S-0.5SH(51)	Reserved for product expansion	6	5.0	2.5	3.57	4.35
FH19-8S-0.5SH(51)	586-1012-2-51	8	6.0	3.5	4.57	5.35
FH19-9S-0.5SH(51)	586-1006-0-51	9	6.5	4.0	5.07	5.85
FH19-13S-0.5SH(51)	586-1001-6-51	13	8.5	6.0	7.07	7.85
FH19-15S-0.5SH(51)	586-1004-4-51	15	9.5	7.0	8.07	8.85
FH19-17S-0.5SH(51)	586-1007-2-51	17	10.5	8.0	9.07	9.85
FH19-20S-0.5SH(51)	586-1002-9-51	20	12.0	9.5	10.57	11.35
FH19-21S-0.5SH(51)	586-1015-0-51	21	12.5	10.0	11.07	11.85
FH19-24S-0.5SH(51)	586-1011-0-51	24	14.0	11.5	12.57	13.35
FH19-27S-0.5SH(51)	586-1000-3-51	27	15.5	13.0	14.07	14.85
FH19-30S-0.5SH(51)	586-1003-1-51	30	17.0	14.5	15.57	16.35
FH19-40S-0.5SH(51)	586-1008-5-51	40	22.0	19.5	20.57	21.35
FH19-50S-0.5SH(51)	586-1005-7-51	50	27.0	24.5	25.57	26.35

Note: Embossed tape reel packaging (5,000 pieces/reel) .

Order by number of reels.



Notes  $\boxed{1}$  The coplanarity of each terminal lead and metal fitting is within 0.1

- $|\overline{2}\rangle$  The contact terminal lead position indicates the dimension from the E surface, the bottom surface of the insulator body.
- 3 The connector is supplied in embossed tape packaging. For details see the Packaging Specifications.
- 4 Any discoloration of the plastic compound will NOT AFFECT form, fit or function of the connector.

Unit: mm

Part Number	CL No.	Number of Contacts	Α	В	С	D
FH19S-4S-0.5SH(51)	586-1119-6-51	4	4.0	1.5	2.57	3.35
FH19S-5S-0.5SH(51)	586-1115-5-51	5	4.5	2.0	3.07	3.85
FH19S-6S-0.5SH(51)	Reserved for product expansion	6	5.0	2.5	3.57	4.35
FH19S-9S-0.5SH(51)	586-1120-5-51	9	6.5	4.0	5.07	5.85
FH19S-10S-0.5SH(51)	586-1118-3-51	10	7.0	4.5	5.57	6.35
FH19S-12S-0.5SH(51)	586-1105-1-51	12	8.0	5.5	6.57	7.35
FH19S-13S-0.5SH(51)	Reserved for product expansion	13	8.5	6.0	7.07	7.85
FH19S-14S-0.5SH(51)	586-1113-0-51	14	9.0	6.5	7.57	8.35
FH19S-16S-0.5SH(51)	586-1112-7-51	16	10.0	7.5	8.57	9.35
FH19S-17S-0.5SH(51)	586-1100-8-51	17	10.5	8.0	9.07	9.85
FH19S-18S-0.5SH(51)	586-1110-1-51	18	11.0	8.5	9.57	10.35
FH19S-20S-0.5SH(51)	586-1101-0-51	20	12.0	9.5	10.57	11.35
FH19S-21S-0.5SH(51)	Reserved product expansion	21	12.5	10.0	11.07	11.85
FH19S-22S-0.5SH(51)	586-1108-0-51	22	13.0	10.5	11.57	12.35
FH19S-24S-0.5SH(51)	586-1102-3-51	24	14.0	11.5	12.57	13.35
FH19S-26S-0.5SH(51)	586-1104-9-51	26	15.0	12.5	13.57	14.35
FH19S-27S-0.5SH(51)	586-1103-6-51	27	15.5	13.0	14.07	14.85
FH19S-30S-0.5SH(51)	586-1109-2-51	30	17.0	14.5	15.57	16.35
FH19S-32S-0.5SH(51)	586-1121-8-51	32	18.0	15.5	16.57	17.35
FH19S-45S-0.5SH(51)	586-1111-4-51	45	24.5	22.0	23.07	23.85
FH19S-50S-0.5SH(51)	586-1107-7-51	50	27.0	24.5	25.57	26.35

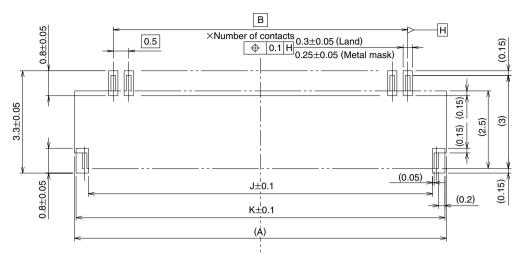
Note: Embossed tape reel packaging (5,000 pieces/reel) .

Order by number of reels.

### Recommended PCB Land and Metal Mask Dimensions

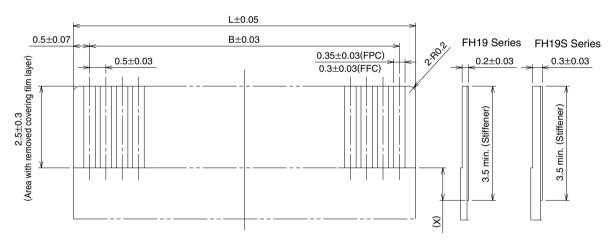
[Common to FH19 & FH19S Series]

Recommended metal mask thickness: 0.10 mm.



### ♠ Recommended FPC, FFC Dimensions

[Common to FH19 & FH19S Series]



Note1: Polyamide and a thermally hardened adhesive is recommended as the materials for the stiffener.

Note2: Y dimension should be 1.5mm min., and X dimension should be 1.5mm for improved flexibility of FPC.

Unit: mm

Number of Contacts Α В J Κ 4 4.0 1.5 3.1 3.9 2.5 4.5 2.0 3.6 4.4 3.0 6 5.0 2.5 4.1 4.9 3.5 8 6.0 3.5 5.1 5.9 4.5 5.0 9 4.0 5.6 6.4 6.5 4.5 6.9 5.5 10 7.0 6.1 12 8.0 5.5 7.1 7.9 6.5 6.0 7.6 8.4 7.0 13 8.5 6.5 7.5 9.0 8.1 8.9 14 8.0 15 9.5 7.0 8.6 9.4 16 10.0 7.5 9.1 9.9 8.5 17 10.5 8.0 9.6 10.4 9.0 18 10.1 11.0 8.5 10.9 9.5 20 12.0 9.5 11.1 11.9 10.5

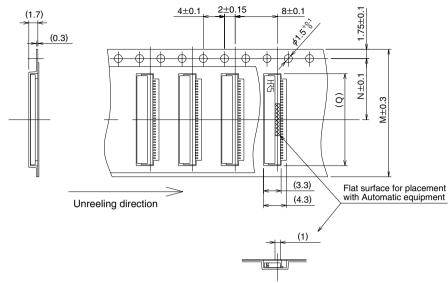
Unit: mm

Number of Contacts	Α	В	J	K	L
21	12.5	10.0	11.6	12.4	11.0
22	13.0	10.5	12.1	12.9	11.5
24	14.0	11.5	13.1	13.9	12.5
26	15.0	12.5	14.1	14.9	13.5
27	15.5	13.0	14.6	15.4	14.0
30	17.0	14.5	16.1	16.9	15.5
32	18.0	15.5	17.1	17.9	16.5
40	22.0	19.5	21.1	21.9	20.5
45	24.5	22.0	23.6	24.4	23.0
50	27.0	24.5	26.1	26.9	25.5

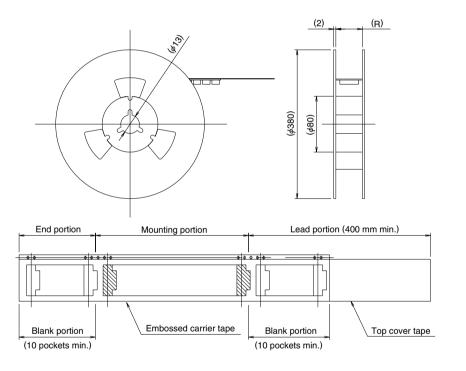
# **●** Packaging Specifications

[Common to FH19 & FH19S Series]

#### Embossed Carrier Tape Dimensions



#### **●**Reel Dimensions



Unit: mm

			Unit: mm	
umbar of Cantagta	N/I	NI.	D	

Number of Contacts	М	N	Q	R
4	16	7.5	4.3	16.5
5	16	7.5	4.8	16.5
6	16	7.5	5.3	16.5
8	16	7.5	6.3	16.5
9	16	7.5	6.8	16.5
10	16	7.5	7.3	16.5
12	16	7.5	8.3	16.5
13	16	7.5	8.8	16.5
14	16	7.5	9.3	16.5
15	16	7.5	9.8	16.5
16	24	11.5	10.3	24.5
17	24	11.5	10.8	24.5
18	24	11.5	11.3	24.5
20	24	11.5	12.3	24.5

Number of Contacts	М	N	Q	R
21	24	11.5	12.8	24.5
22	24	11.5	13.3	24.5
24	24	11.5	14.3	24.5
26	24	11.5	15.3	24.5
27	24	11.5	15.8	24.5
30	24	11.5	17.3	24.5
32	32	14.2	18.3	32.5
40	44	20.2	22.3	44.5
45	44	20.2	24.8	44.5
50	44	20.2	27.3	44.5

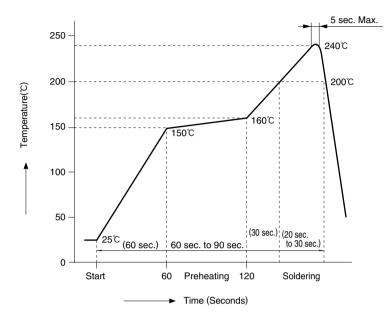
Notes: 5,000 pieces per reel.

Embossed tape 32 mm or wider will have perforated feed holes on two sides.

### ◆Recommended Temperature Profile

[For FH19 & FH19S Series]

#### Using Typical Solder Paste



#### **HRS** test conditions

Solder method :Reflow, IR/hot air

(Nihon Den-netsu Co., Ltd.'s

Part Number: SENSBY NR- Ⅱ)

Environment :Room air

Solder composition :Paste, 63%Sn/37%Pb

(Senju Metal Industry, Co., Ltd.'s Part

Number: OZ63-201C-50-9)

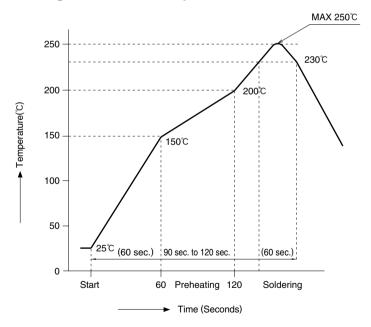
Test board :Glass epoxy 45mm×100mm×1.6mm thick

Land dimensions :0.3mm×0.8mm

Metal mask :0.25mm×0.8mm×0.1mm thick

This temperature profile is based on the above conditions. In individual applications the actual temperature may vary, depending on solder paste type, volume/thickness and board size/thickness. Consult your solder paste and equipment manufacturer for specific recommendations.

#### ●Using Lead-free Solder paste



#### HRS test condition

Solder method :Reflow, IR/hot air

(Nihon Den-netsu Co., Ltd.'s Part Number: SENSBY NR- Ⅱ)

Environment :Room air

Solder composition :Paste, 96.5%Sn/3.0%Ag/0.5%Cu

(Senju Metal Industry, Co., Ltd.'s Part Number:M705-221CM5-42-10.5)

Test board :Glass epoxy 45mm×100mm×1.6mm thick

Land dimensions : 0.3mm×0.8mm

Metal mask :0.25mm×0.8mm×0.1mm

In individual applications the actual temperature may vary, depending on solder paste type, volume/thickness and board size/thickness. Consult tour solder paste and equipment manufacturer for specific recommendations.

# FH19 & FH19S Series FPC/FFC Construction (Recommended Specifications)

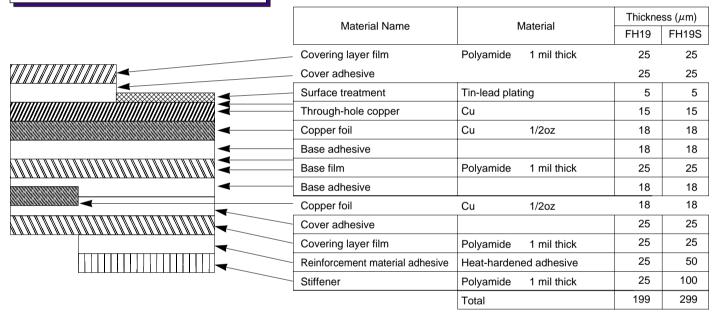
# 1. Using Single-sided FPC

### **FPC: Flexible Printed Circuit**

	Material Name	Material -	Thickne	ss (µm)
	iviateriai Name	iviateriai	FH19	FH19S
\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	Covering film layer.	Polyamide 1 mil thick	25	25
	Cover adhesive		25	25
	Surface treatment	Tin-lead plating	5	5
<b>—</b>	Copper foil	Cu 1oz	35	35
	Base adhesive		25	25
	Base film	Polyamide 1 mil thick	25	25
	Reinforcement material adhesive	Heat-hardened adhesive	30	30
	Stiffener	Polyamide 3 mil thick	75	175
		Total	195	295

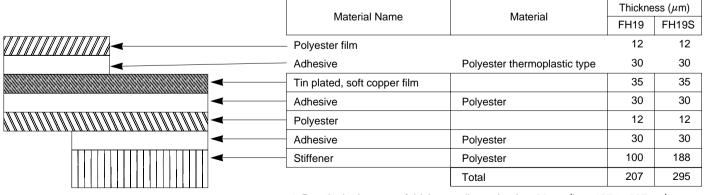
### 2. Dual-sided FPC

#### **FPC: Flexible Printed Circuit**



# 3. Using FFC (Flexible Flat Cable)

## FFC: Flexible Flat Cable



<sup>\*</sup> Practical tolerance of thickness dimension is  $\pm 20 \mu m$  (i.e., 187 to 227 $\mu m$ ).

Note 1: The 0.2mm thick FFC is the 0.3mm thick FFC with different stiffener.

Note 2: This specification is a recommendation for the FH19, FH19S Series connectors using FPC/FFC 0.2/0.3 ±0.03mm thick.

This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.